IRFBC30

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TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_a max. (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

2.2

600

31

4.6

17

Single

 $V_{GS} = 10 V$

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRFBC30PbF			
Lead (Pb)-free and halogen-free	IRFBC30PbF-BE3			

PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			V _{DS}	600	- V		
Gate-source voltage			V _{GS}	± 20			
Continuous drain current	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C		3.6			
		T _C = 100 °C	I _D	2.3	А		
Pulsed drain current ^a			I _{DM}	14	7		
Linear derating factor				0.59	W/°C		
Single pulse avalanche energy ^b			E _{AS}	290	mJ		
Repetitive avalanche current ^a			I _{AR}	3.6	3.6 A		
Repetitive avalanche energy ^a			E _{AR}	7.4	mJ		
Maximum power dissipation	$T_{\rm C} = 2$	25 °C	PD	74	W		
Peak diode recovery dV/dt ^c			dV/dt 3.0		V/ns		
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C		
Soldering recommendations (peak temperature) ^d	For 10 s			300			
Mounting torque	6-32 or M3 screw			10	lbf ∙ in		
				1.1	N · m		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 41 mH, R_g = 25 Ω , I_{AS} = 3.6 A (see fig. 12)

c. $I_{SD} \le 3.6$ A, dl/dt ≤ 60 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C

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THERMAL RESISTANCE RAT	INGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R _{thJA}	-		62					
Case-to-sink, flat, greased surface	R _{thCS}	0.50	0.50 -			°C/W			
Maximum junction-to-case (drain)	R _{thJC}	-		1.7	1				
	•					•			
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherw	ise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		ONS	MIN.	TYP.	MAX.	UNIT	
Static	1	1				1	1		
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0	V, I _D = 25	0 μΑ	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C, I _l) = 1 mA	-	0.62	-	V/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_0$	_{3S} , I _D = 25	0 μΑ	2.0	-	4.0	V	
Gate-source leakage	I _{GSS}		$_{3} = \pm 20 \text{ V}$		-	-	± 100	nA	
			00 V, V _{GS} :		-	-	100		
Zero gate voltage drain current	Itage drain current I_{DSS} $V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		Г _Ј = 125 °С	-	-	500	μA		
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V		= 2.2 A ^b	-	-	2.2	Ω	
Forward transconductance	9 _{fs}		0 V, I _D = 2	.2 A ^b	2.5	-	-	S	
Dynamic	1	,				1	1		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$			-	660	-	pF	
Output capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	86	-			
Reverse transfer capacitance	C _{rss}			-	19	-			
Total gate charge	Qg				-	-	31	nC	
Gate-source charge	Q _{gs}	V _{GS} = 10 V		$V_{DS} = 360 V$,	-	-	4.6		
Gate-drain charge	Q _{gd}	see fig. 6 and 13 ^b			-	-	17		
Turn-on delay time	t _{d(on)}				-	11	-		
Rise time	t _r	V_{DD} = 300 V, I_D = 3.6 A , R_g = 12 Ω,R_D = 82 $\Omega,$ see fig. 10 $^{\rm b}$			-	13	-	ns	
Turn-off delay time	t _{d(off)}				-	35	-		
Fall time	t _f				-	14	-		
Gate input resistance	Rg	f = 1 MHz, open drain			0.5	-	4.9	Ω	
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact			-	4.5	-	nH	
Internal source inductance	L _S				-	7.5	-		
Drain-Source Body Diode Characterist	ics	•				•	•	•	
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3.6	A		
Pulsed diode forward current ^a	I _{SM}			-	-	14			
Body diode voltage	V _{SD}	$T_{\rm J}$ = 25 °C, I _S = 3.6 A, V _{GS} = 0 V ^b		-	-	1.6	V		
Body diode reverse recovery time	t _{rr}			-	370	810	ns		
Body diode reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = 3.6 \text{ A}, dl/dt = 100 \text{ A}/\mu \text{s}^{\text{b}}$			-	2.0	4.2	μC	
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)							

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

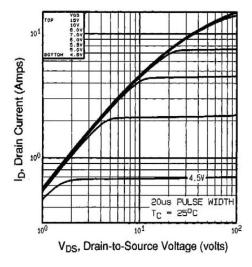


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

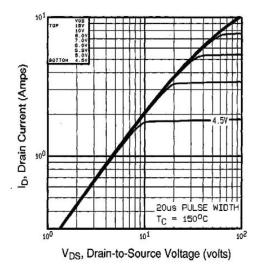


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

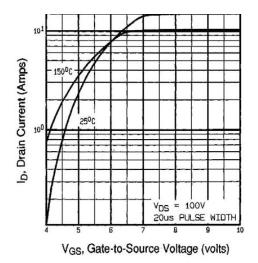


Fig. 3 - Typical Transfer Characteristics

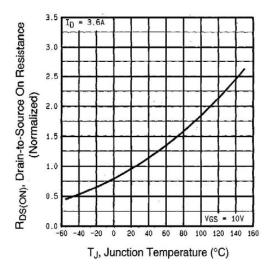


Fig. 4 - Normalized On-Resistance vs. Temperature

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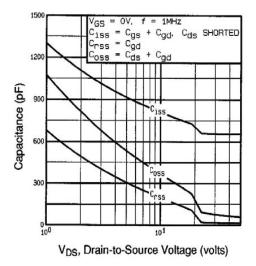
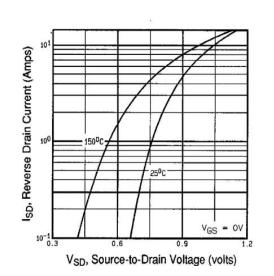


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





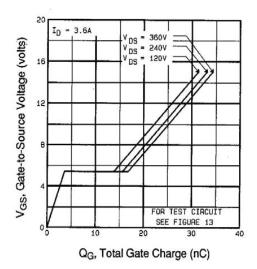


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

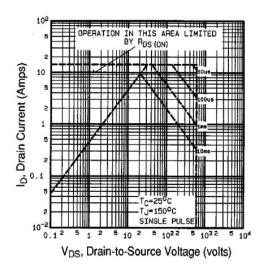


Fig. 8 - Maximum Safe Operating Area

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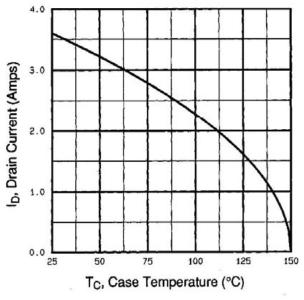


Fig. 9 - Maximum Drain Current vs. Case Temperature

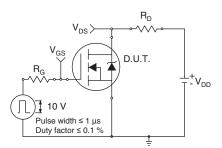


Fig. 10a - Switching Time Test Circuit

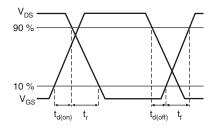


Fig. 10b - Switching Time Waveforms

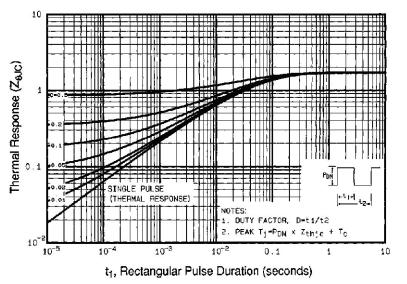


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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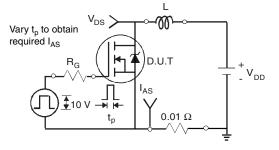


Fig. 12a - Unclamped Inductive Test Circuit

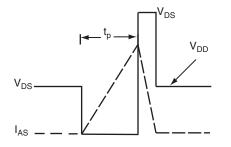
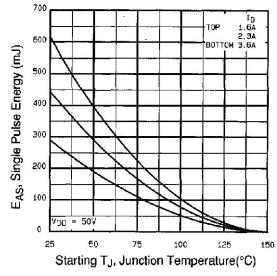


Fig. 12b - Unclamped Inductive Waveforms





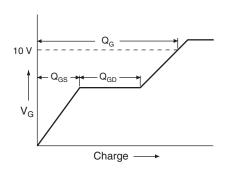
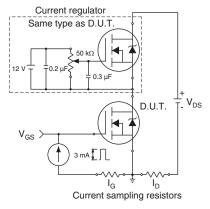


Fig. 13a - Basic Gate Charge Waveform





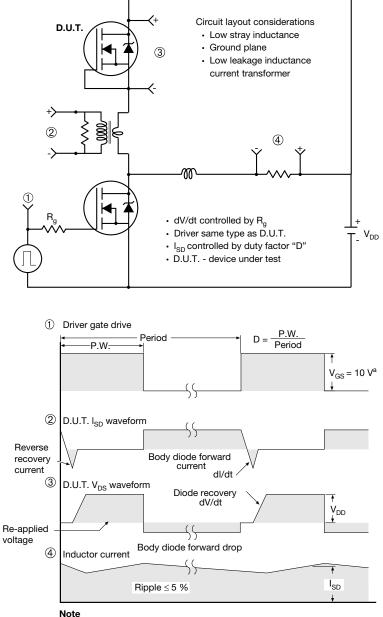




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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

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